

Transistor(NPN)

Features

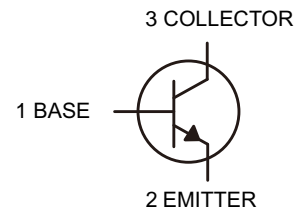
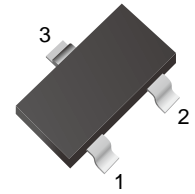
- Power Dissipation of 300mW
- High Stability and High Reliability
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case:SOT-23
- EpoxyUL:94V-0
- Mounting Position:Any
- Approx. Weight: 8.1mg

Ordering Information

Part Number	Marking	Shipping	Reel
LTM8050-TR3	Y11	3000PCS Tape&Reel	7 inches
LTM8050-TR12	Y11	12000PCS Tape&Reel	13 inches



Maximum Ratings & Thermal Characteristics

Ratings at 25°C ambient temperature unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	40	V
Collector-Emitter Voltage	V _{CEO}	25	V
Emitter -Base Voltage	V _{EBO}	6	V
Collector Current-Continuous	I _c	800	mA
Collector Power Dissipation	P _c	300	mW
Junction Temperature	T _j	150	°C
Storage Temperature	T _{stg}	-55-+150	°C
Thermal resistance From junction to ambient	R _{θJA}	417	°C/W

Electrical characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	Test Condition	Limits		Unit
			Min	Max	
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =100μA, I _E =0	40		V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =1mA, I _B =0	25		V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =100μA, I _C =0	6		V
Collector cut-off current	I _{CBO}	V _{CB} =35V, I _E =0		100	nA
Collector cut-off current	I _{CEO}	V _{CE} =20V, I _B =0		100	nA
DC current gain	h _{FE} (1)	V _{CE} =1V, I _C =5mA	45		
	h _{FE} (2)	V _{CE} =1V, I _C =100mA	80	400	
	h _{FE} (3)	V _{CE} =1V, I _C =800mA	40		
Collector-emitter saturation voltage	V _{CE(sat)}	I _C =800mA, I _B =80mA		0.50	V
Base -emitter saturation voltage	V _{BE(sat)}	I _C =800mA, I _B =80mA		1.20	V
Transition frequency	f _T	V _{CE} =6V, I _C =20mA, f=30MHz	150		MHz



Characteristics Curves

Fig.1 Static Characteristic

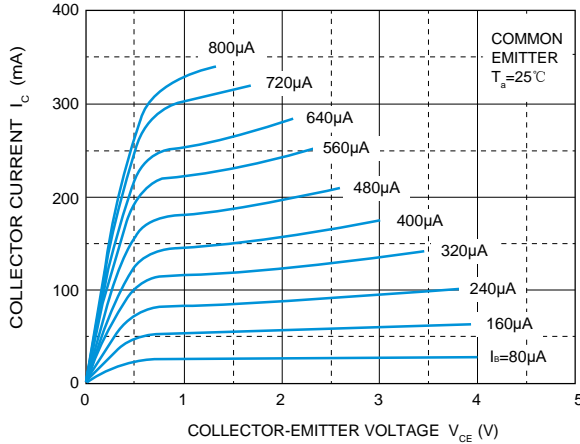


Fig.2 h_{FE} vs I_c

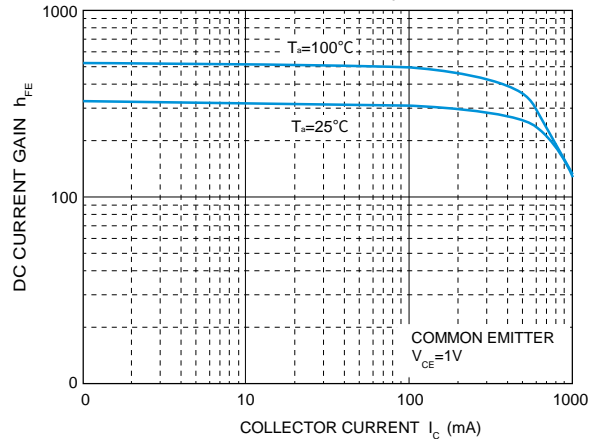


Fig.3 V_{CEsat} vs I_c

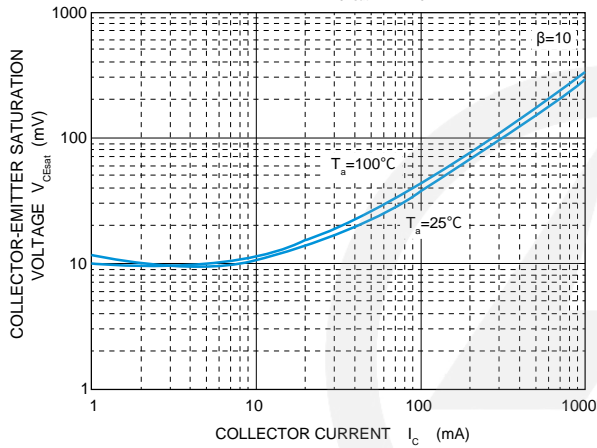


Fig.4 V_{BEsat} vs I_c

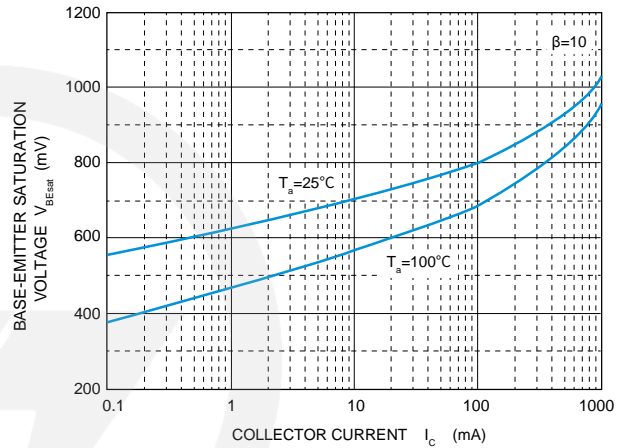


Fig.5 C_{ob}/C_{ib} vs V_{CB}/V_{EB}

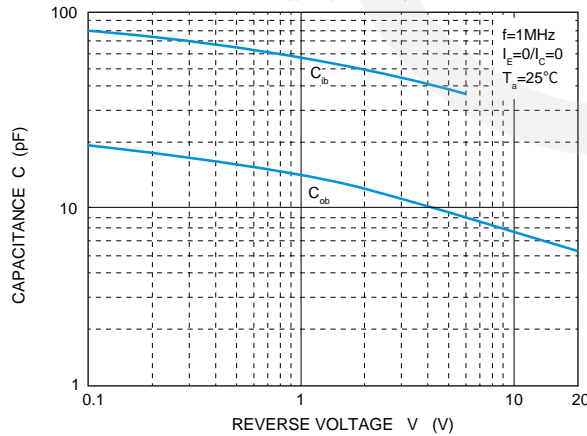


Fig.6 f_T vs I_c

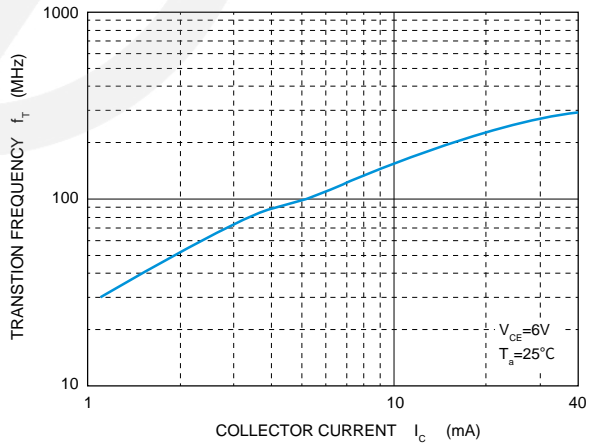
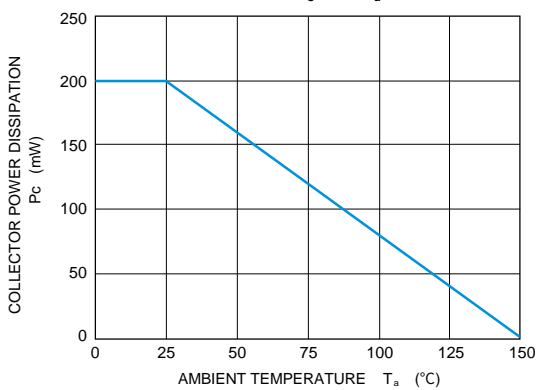


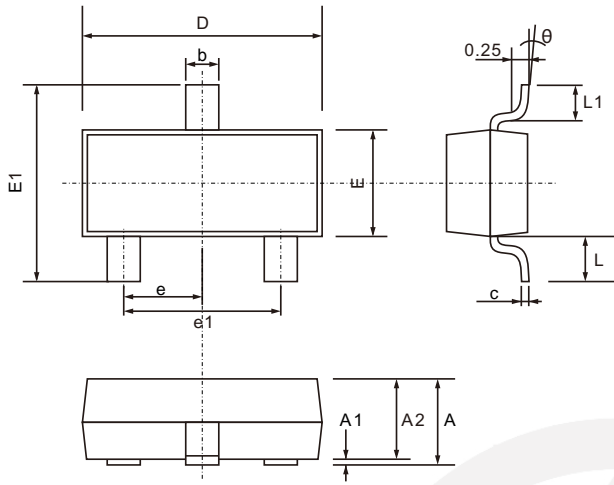
Fig.7 P_c vs T_a





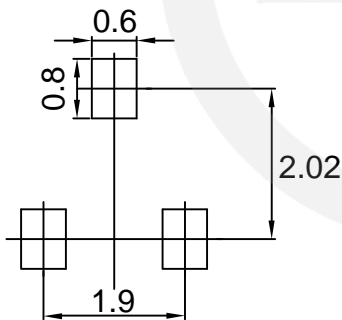
SOT-23 Package Outline

Unit: mm



SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	0.900	1.200
A1	0.000	0.100
A2	0.900	1.050
b	0.300	0.500
c	0.080	0.200
D	2.700	3.100
E	1.200	1.400
E1	2.200	2.600
e	0.950 TYP.	
e1	1.750	2.050
L	0.550 TYP.	
L1	0.300	0.500
θ	0°	8°

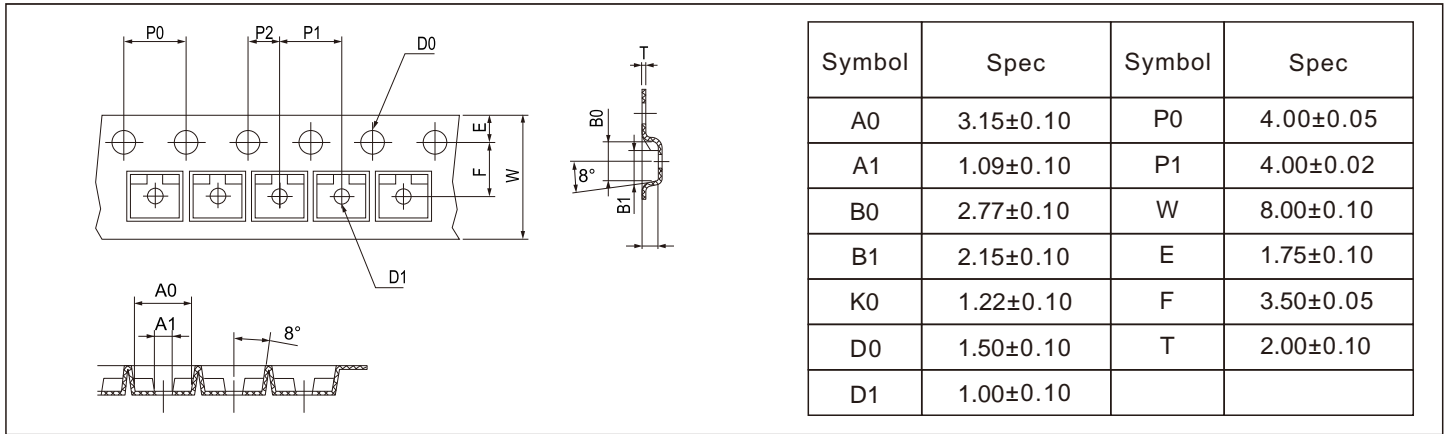
SOT-23 Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
 2. General tolerance: $\pm 0.05\text{mm}$
 3. The pad layout is for reference purpose only.

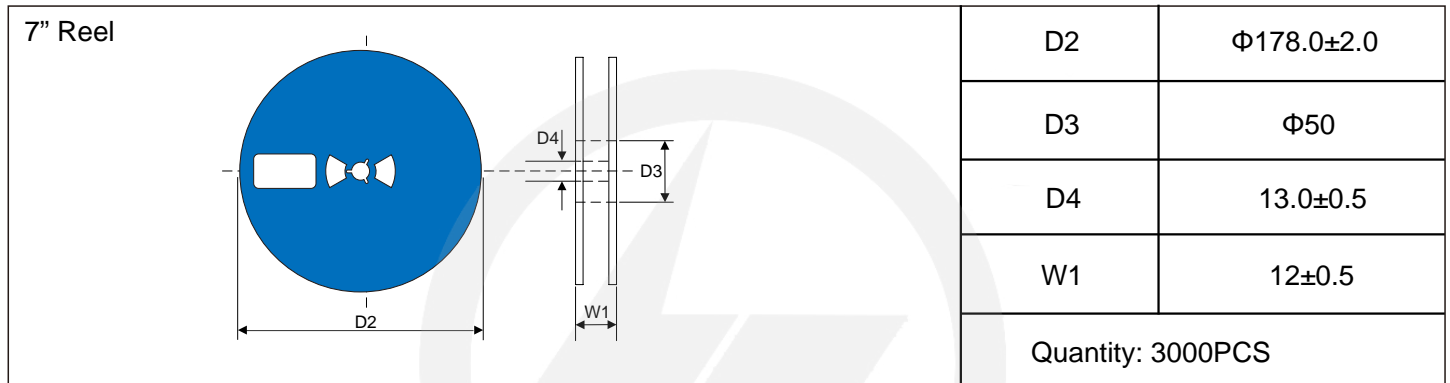
Carrier Tape Dimensions

Unit : mm



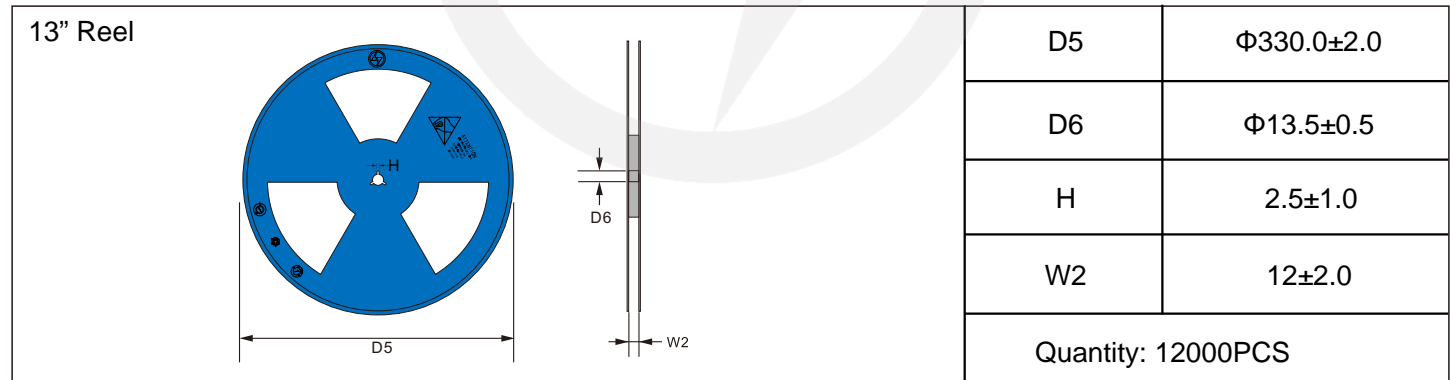
Reel Dimensions

Unit : mm

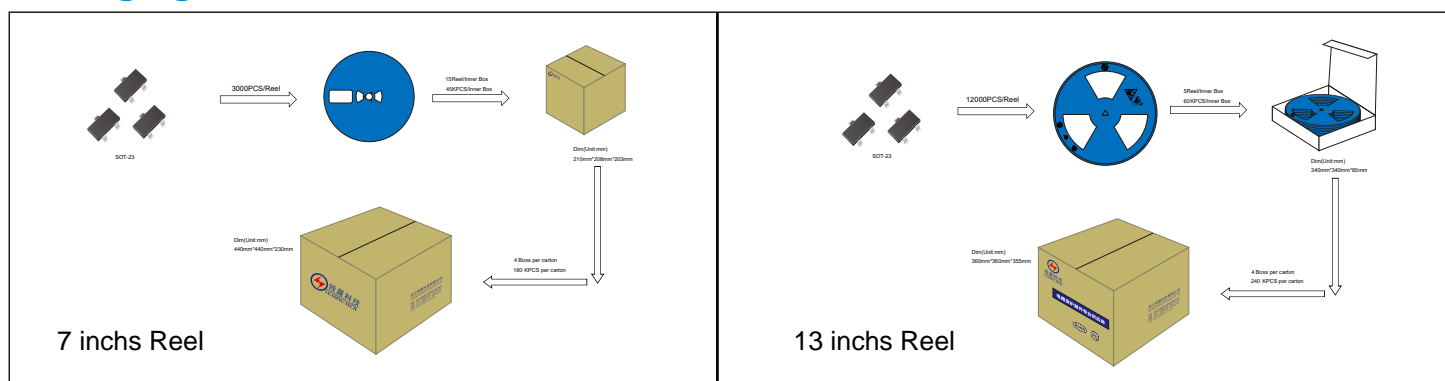


Reel Dimensions

Unit : mm

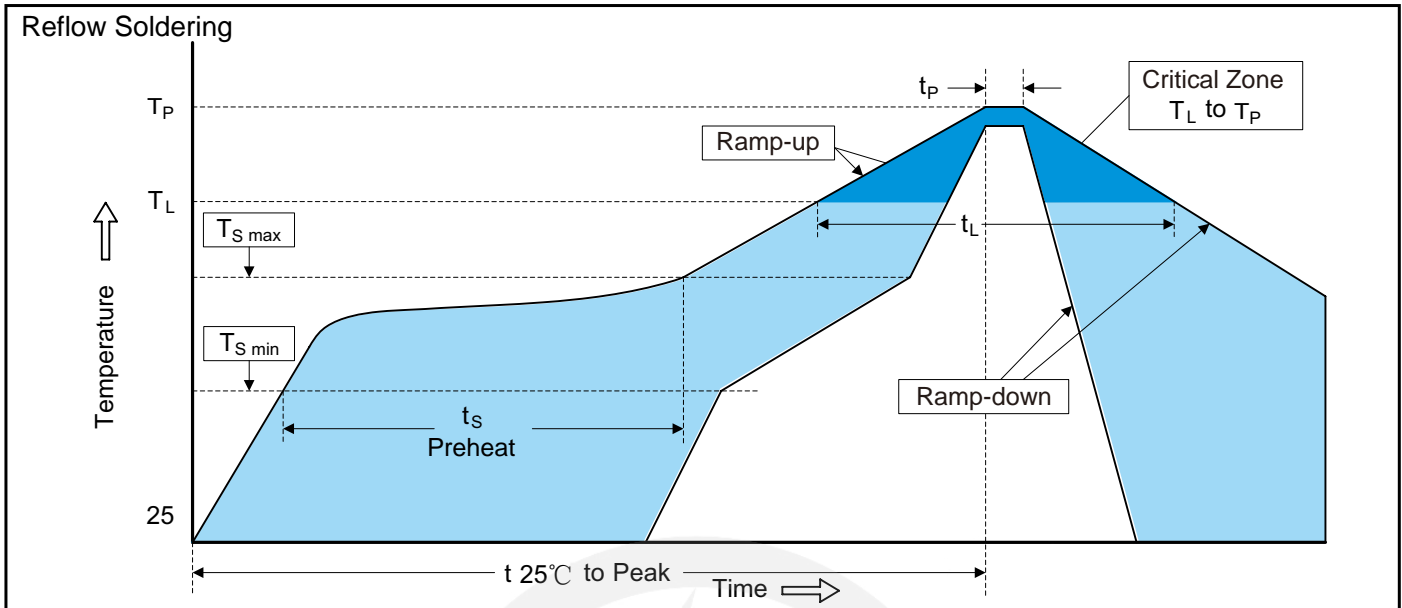


Packaging





Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second max.
Preheat	
-Temperature Min (T _{S min})	150°C
-Temperature Max (T _{S max})	200°C
-Time (min to max) (t _s)	60-180 seconds
T _{S max} to T _L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T _L)	217°C
-Time (t _L)	60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (t _p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.

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Version Update Information

Series NO.	Enactment/Revision Date	Effective Date	Version	Revision Content	Revision Reason	Revision Person	Note
01	2024.04.12	2024.04.12	3.0	New file	/	Ding	
02	2025.06.12	2025.06.12	3.1	Update packaging information	/	Ding	
03	2026.03.06	2026.03.06	3.2	Package outline E1(max)=2.6mm	/	Ding	